Correlating Structure and Morphology to Device Performance of Molecular Organic Donor–Acceptor Photovoltaic Cells Based on Diindenoperylene (DIP) and C₆₀

M. Gruber, M. Rawolle, J. Wagner, D. Magerl, U. Hörmann, J. Perlich, S. V. Roth, A. Opitz, F. Schreiber, P. Müller-Buschbaum, and W. Brütting*

The performance of organic photovoltaic cells (OPVCs) shows a critical dependence on morphology and structure of the active layers. In small molecule donor/acceptor (D/A) cells fabrication parameters, like substrate temperature and evaporation rate, play a significant role for crystallization and roughening of the film. In particular, the fraction of mixed material at the interface between donor and acceptor is highly relevant for device performance. While an ideal planar heterojunction (PHJ) exhibits the smallest possible interface area resulting in suppressed recombination losses, mixed layers suffer strongly from recombination but show higher exciton dissociation efficiencies. In this study we investigate PHJ and planar-mixed heterojunction (PM-HJ) solar cells based on diindenoperylene (DIP) as donor and C₆₀ as acceptor, fabricated under different growth conditions. Grazing incidence small angle X-ray scattering (GISAXS), X-ray reflectometry (XRR) and atomic force microscopy (AFM) are used to obtain detailed information about in- and out-of-plane structures and topography. In that way we find that surface and bulk domain distances are correlated in size for PHJs, while PM-HJs show no correlation at all. The resulting solar cell characteristics are strongly affected by the morphology, as reorganizations in structure correlate with changes in the solar cell performance.

light-induced excitons are usually localized on one single molecule, transport is dominated by exciton-hopping resulting in short exciton diffusion lengths (EDLs) of only a few nanometers, depending on the structural order of the material. Many commonly used materials are dominated by amorphous growth showing EDLs of typically 10 nm or less,^[2–4] while crystalline materials like diindenoperylene (DIP) can reach EDLs of up to 100 nm in thermally evaporated thin films.^[5]

Not only is exciton transport hindered in organic semiconductors, but also is the charge carrier mobility. Depending on the details of film growth, differences in mobility can be huge. While amorphous materials show mobilities of typically 10^{-3} cm²/Vs or less at room temperature due to hopping transport of charge carriers in a Gaussian density of states, highly crystalline films almost show bandlike transport with mobilities that are several orders of magnitude higher.^[6,7]

For efficient exciton dissociation, Tang et al. introduced the donor/acceptor (D/A) concept.^[8] Comprising such a het-

1. Introduction

Charge carrier and exciton transport are important issues in the field of organic semiconductor devices. Owing to weak intermolecular coupling and low dielectric constants the binding energies of photo-generated Frenkel-excitons (typically in the range of a few tenths of an eV for materials relevant in photovoltaics) are too high to be separated by thermal energy at room temperature.^[1] Because

M. Gruber, J. Wagner, U. Hörmann, Prof. W. Brütting Institut für Physik Universität Augsburg Universitätsstr.1, 86135 Augsburg, Germany E-mail: wolfgang.bruetting@physik.uni-augsburg.de M. Rawolle, D. Magerl, Prof. P. Müller-Buschbaum Physik-Department Lehrstuhl für funktionelle Materialien Technische Universität München James-Frank-Str.1, 85748 Garching, Germany

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erojunction several architectures for organic photovoltaic cells (OPVCs) have been proposed with varying amount of mixed material at the interface leading to increased exciton dissociation probability, but also the tendency for enhanced charge carrier recombination for larger interfacial areas.^[9–11] One extreme can be found in the ideal planar heterojunction (PHJ) without any fraction of mixed material and a flat interface. To overcome the bottleneck of short EDLs, a D:A mixture forming a

Dr. J. Perlich, Dr. S. V. Roth HASYLAB at DESY, Notkestr.85 22603 Hamburg, Germany A. Opitz Institut für Physik Supramolekulare Systeme Humboldt-Universität zu Berlin Brook-Taylor-Straße 6, 12489 Berlin, Germany Prof. F. Schreiber Institut für Angewandte Physik Universität Tübingen Auf der Morgenstelle 10, 72076 Tübingen, Germany





bulk heterojunction (BHJ) exhibits the largest possible interface leading to a reduced pathway for excitons to reach the dissociating interface.^[12-14] In the case of BHJs two types have to be distinguished. While the combination of two structurally compatible molecules allows for the formation of one molecularly mixed phase and in some cases even an ordered mixed crystal is possible, BHJs with structurally unlike molecules in shape normally form phase-separated structures.^[15,16] Both concepts of BHJs have the advantage of providing short distances for excitons to reach the interface within their EDL. However, the absence of percolation paths in molecularly mixed crystals causes severe problems for charge carrier transport towards the electrodes.^[15,16] Thus, reasonable results, when applied in solar cells, can only be achieved with PHJs, phase separated BHJs and a combination of both concepts in so-called planar-mixed heterojunctions (PM-HJs).

In our study we investigate the impact of morphology on OPVCs with highly crystalline materials, namely diindenoperylene (DIP) as donor and C_{60} as acceptor. The effect of different growth conditions were studied in PHJs, which strongly affect the lateral grain size. In previous work on this material system it was shown that fabrication parameters like substrate temperature and evaporation rate play a significant role for crystallization and roughening of the film.^[16–20] However, also the fraction of mixed material at the interface between donor and acceptor is highly relevant.^[21] In the present study, we systematically investigate how changes of morphology, both in the bulk and at the surface of the film, affect crystallinity and solar cell performance.

The morphology in the volume of the films is investigated by grazing incidence small angle X-ray scattering (GISAXS),^[22] which provides information about domain distances in the bulk of the material. The volume information is compared with the domain distances of topography scans performed by atomic force microscopy (AFM). X-ray reflectometry (XRR) measurements are used to gain information on the crystallization behavior of both active materials in vertical direction. It is found that lateral domain distances in the bulk and at the surface of PM-HJs differ strongly. This is attributed to the pronounced phase separation of DIP and C₆₀. Solar cells fabricated under comparable growth conditions and film thicknesses show increased j_{SC} in PM-HJs and increased FF in PHJs, respectively. These two effects compensate each other and result in nearly the same power conversion efficiency η for both systems.

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the acceptor C_{60} from Creaphys in Dresden. The two photoactive molecular materials were twice purified by gradient sublimation before usage. Bathocuproine (BCP) was used as received from Sigma Aldrich for exciton blocking and protection against metal interdiffusion.^[23,24]

The samples were prepared using organic molecular beam deposition at a base pressure smaller than 10^{-7} mbar. DIP and C_{60} were thermally evaporated in one chamber without breaking the vacuum at deposition rates of about 0.5 Å/s for single material deposition. In the case of coevaporation of both materials the combined deposition rate was about 0.6 Å/s. Further morphological and structural measurements were performed in air. For solar cell preparation the samples with DIP/C₆₀ were transferred to a glovebox that provides inert atmosphere without exposing the samples to air. In a second vacuum chamber directly connected to the glovebox the BCP layer and the aluminum electrode were evaporated with deposition rates of 0.3 Å/s and 1.0 Å/s, respectively.

Structural and topographical investigations were performed for neat DIP films deposited on differently heated silicon oxide substrates (room temperature (RT), 60 °C and 100 °C) and on heterostructures, where DIP films grown on heated substrates (100 °C) were subsequently covered with C_{60} with and without further substrate heating during evaporation of C_{60} (RT and 100 °C). Layer thicknesses were 50 nm for DIP and 40 nm for C_{60} . The corresponding OPVCs were fabricated using identical active layer stacks on top of pre-heated PEDOT:PSS covered ITO substrates.

Moreover, we fabricated a sample with PM-HJ architecture, i.e. a neat 4 nm thick evaporated DIP layer was followed by a 36 nm thick co-evaporated mixture of DIP and C_{60} in a 1:1 volume ratio, all deposited at a substrate temperature of 100 °C. The corresponding solar cell included an additional layer of 6 nm C_{60} , which was evaporated on top of the blend to complete the PM-HJ architecture. For better insight into the mixed material this layer was left out for morphological and structural investigations.

Exciton blocking and protection from metal incorporation in solar cells was granted by a 5 nm thick BCP layer covering the active layers topped by the electrical contact Al. In total, there were five different OPVCs.

Film and Solar Cell Characterization: Grazing incidence small angle X-ray scattering (GISAXS) allows for obtaining statistically relevant structural information in the volume of thin films, with tunable sensitivity to the film surface by changing the incident angle.^[22,25] The basic setup is shown in **Figure 1**

2. Experimental Section

Sample Preparation: For structural and topographical measurements we used silicon substrates overgrown with a 320 nm thick thermal SiO_2 layer, while solar cells were fabricated on indium tin oxide (ITO) coated glass substrates. As hole extraction layer for solar cells a 30 nm thick poly(3,4-ethylenedioxythiophene): poly(styrenesulfonate) (PEDOT:PSS, purchased from Clevios as Baytron P AI4083) film, was spin-coated on top of the ITO layer.

The donor DIP was purchased from S. Hirschmann (Univ. Stuttgart, Germany),



Figure 1. a) Sketch of the GISAXS setup, the beam impinges on the sample under a very shallow angle α_i and exits the sample under an angle α_f in the scattering plane (xz-plane) and an angle Ψ out of the scattering plane (xy-plane). b) Sketch of the fast Fourier transformation (FFT) analysis of the AFM images.



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a: the X-ray beam impinges on the sample under a shallow incident angle α_i , typically well below 1°. The reflected scattering signal is detected on a two-dimensional detector, where the direct beam and the specularly reflected beam are each blocked by a beam stop. To obtain more information about lateral structures as probed parallel to the sample surface, a rod-like beam stop that blocks the intensity in z-direction around $q_v = 0$ can shield the detector in addition.

GISAXS measurements have been performed at the beamline BW4 of HASYLAB at DESY, Hamburg, with a sample-to-detector distance of 2.2 m and a wavelength of 0.138 nm.^[26] The incident angle was chosen as 0.35°, which is well above the critical angle for total reflection of the measured materials (0.162° for DIP and 0.167° for C_{60}), enabling to probe structural information in the whole volume of the thin films with good resolution. The refractive index for DIP at the used X-ray wavelength is $n = 1 - 4.02 \cdot 10^{-6} +$ i 5.55 \cdot 10^{-9} and for C_{60} it is n = 1 – 4.25 \cdot 10^{-6} + i 6.36 \cdot 10⁻⁹. The size of the moderately focused synchrotron beam was set to (23×36) μ m² (vertical × horizontal), resulting in a footprint of the X-ray beam of 3.8 mm by 36 µm on the sample. The scattered X-ray signal was detected with a MarCCD detector of 2048 \times 2048 pixels with a pixel size of $(79.1 \,\mu\text{m})^2$.

The data were analyzed by fitting lateral structure sizes with the effective interface approximation (EIA).^[22] To prove the validity of this approach, selected data sets were also simulated with the IsGISAXS software.^[27] The characteristic lateral structures obtained from simulation agree well with the ones of the effective interface approximation, but yield additional information about shape and distribution of the structures in the sample.

Surface topography was investigated using AFM (Thermo Microscopes Autoprobe CP-Research) in non-contact mode with an NSG30 (NT-MDT) tip with a pyramidal shape and 22-100 N/m spring constant probing an

area of 4 × 4 μ m². Fast Fourier transformation (FFT) of the signal provides distance distributions (see Figure 1b). To interpret the results, data were averaged over the whole angle range of Θ (see Figure 1) and fitted by Gaussian distributions. These fits provide the average domain distances of the associated AFM signal.

XRR was performed for the samples on SiO₂ using an XRD 3003 PTS (Seifert) with a wavelength of 0.154 nm, a slit collimation system and a scintillation counter SZ 20/SE (Seifert). From these data, information about vertical domain sizes was obtained using the Scherrer equation.

Current–voltage characteristics were recorded from -0.5 V to 1.5 V in 0.05 V steps using a source measure unit (Keithley 236 SMU) in dark and under illumination with a solar simulator



Figure 2. AFM topography images of neat DIP films on unheated and heated substrates (a–c), bilayers with C_{60} on top of DIP for unheated and heated substrates during C_{60} deposition (d,e) and a 1:1 mixed layer of DIP and DIP: C_{60} on top of a thin DIP seed layer on a heated substrate (f).

(Oriel 300W with AM 1.5G filters) in a glovebox system with nitrogen atmosphere. The illumination intensity was approved by a calibrated silicon reference cell (RERA systems, PV Measurement Facility, Radboud University Nijmegen, area 1×1 cm²).

3. Results and Discussion

3.1. Influence of Substrate Temperature on DIP Structure

The AFM measurements of DIP films evaporated onto silicon substrates at different temperatures (see Figure 2a–c) show an





Figure 3. Angle averaged FFT of the corresponding AFM images shown in Figure 2 fitted with two Gaussian distributions each leading to average domain distances summarized in Table 1.

increasing lateral DIP surface domain size and domain distance with increasing temperature. The morphology can be described as sphere- or granule-like objects. The lateral domain distances of these surface structures are extracted from FFT of the AFM images (see **Figure 3**). For all three temperatures two characteristic lateral distances are found. In addition, XRR (not shown) reveals a constant out-of-plane lattice parameter and a vertical coherence length essentially equivalent to the layer thickness, as derived from the width of the Bragg peak,

independent of preparation temperature in the range studied. A similar behavior was reported in Ref. [20,28].

The 2-dimensional GISAXS data (see Figure 4) exhibit a characteristic shape with Bragg rod-like intensity streaks originating from the lateral DIP structure. The position of the Bragg-rods moves towards smaller $q_{\rm v}$ -values with increasing evaporation temperatures. To quantify this information, the horizontal line cuts (in q_v -direction) at the critical angle of DIP are shown in Figure 5 with the corresponding fits based on the EIA. As in the FFT of the AFM data two characteristic lateral lengths are extracted. With increasing temperature the size of these characteristic lateral structures increases (see Table 1). Within the experimental error bars. the values of the small and large structures determined by GISAXS agree with the values as obtained from AFM measurements (also included in Table 1). Both show an increasing DIP domain distance with higher evaporation temperature. However, the GISAXS values tend to be slightly larger. Probably this is an effect of statistics, as AFM is a local probe at the surface, whereas GISAXS averages structural features in a larger sample volume.

To gain information on structures perpendicular to the substrate, vertical cuts (in q_z -direction) at different positions are performed. For vertical cuts at $q_y = 0$, representing very large structures in the resolution limit of the GISAXS experiment, no intensity oscillations are present for q_z values above the specular peak (approximately at 0.6 nm⁻¹). Therefore these large, unresolved structures show no correlated roughness (i.e. the topography of the film differs from the topography of the underlying substrate) irrespective of the substrate temperatures.^[29,30] In contrast, for small distances, i.e. at q_y values well outside the resolution limit, correlated roughness is observed for all substrate temperatures during evaporation. Correspondingly, in the q_2 -cut at the position of the intensity maximum in q_v intensity oscillations are present

3.2. DIP Films on Heated Substrates, Covered with C_{60} with and Without Further Substrate Heating

For DIP films on heated substrates (100 °C) covered with C_{60} with and without further substrate heating AFM and GISAXS measurements are performed to detect the in-plane structures. AFM again exhibits two characteristic lateral lengths, whereas in GISAXS a third lateral structure is found. For the structures seen with AFM and GISAXS, a decreasing domain size and



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Figure 4. 2d-GISAXS data of neat DIP films on heated substrates (a–c), bilayers with C_{60} on top of DIP for unheated and heated substrates during C_{60} deposition (d,e) and a 1:1 mixed layer of DIP and C_{60} on top of a thin DIP seed layer on a heated substrate (f).

domain distance is found with increasing substrate temperature during C₆₀ evaporation, starting from a value similar to the domain size of the neat DIP layer evaporated at 100 °C. C₆₀ evaporation shows different influence on the underlying DIP layer depending on the substrate temperature. While C₆₀ just overgrows the DIP for the unheated substrate preserving the underlying morphology (see Figure 2c,d), it leads to reorganization of the DIP film in the case of a heated substrate during C₆₀ evaporation (see Figure 2e). This cannot be observed in AFM measurements as DIP is covered by C₆₀, but GISAXS measurements show shrinking lateral domain distances (see Figure 5), while the vertical component is preserved (see Table 1). Additionally, C_{60} growth changes,



Figure 5. Horizontal line cuts of the 2d-GISAXS data at the critical angle fitted with EIA providing lateral domain distances in the bulk of the films. The curves for the neat DIP film grown at RT, the two bilayers and the mixed layer are fitted with two values for lateral domain distances, while the remaining two curves for heated DIP neat films can only be fitted accurately with three values. Curves are shifted along the intensity axis for clarity.

i.e. it forms films with higher crystallinity, as probed by XRR. These measurements show enhanced domain sizes of about 46 nm (best crystalline coherence in C_{60} for the presented samples) in vertical direction compared to approximately 22 nm in

Table 1. Structural and topographical measurements were performed on samples with DIP, DIP/C₆₀ and DIP/DIP:C₆₀ layers deposited on SiO₂ substrates at different temperatures as specified in the second column. EIA fits of GISAXS data and FFT fits of AFM data yield lateral domain distances with an error of $\pm 3\%$ and $\pm 7\%$, respectively. The same accuracy of $\pm 7\%$ is given for R_{rms} of AFM data, while the Gaussian fits of XRR data reveal vertical coherence lenghts with an error of about $\pm 10\%$. The given lengths in the Table have been obtained for the particular series of samples shown in Figure 2-5. Note that the less prominent second and third length scale are not easily deconvoluted in every sample.

Layer Sequence (Thickness [nm])	Temp. [°C]	Lat. dom. dis. (GISAXS) [nm]	Lat. dom. dis. (AFM) [nm]	R _{rms} (AFM) [nm]	Vert. cor. len. (XRR) [nm]
DIP(50)	RT	45, 160	65, 151	4.5	53
DIP(50)	60	80, 205	89, 181	6.0	51
DIP(50)	100	205, 430	171, 416	3.9	54
DIP(50)/C ₆₀ (40)	100/RT	12, 205, 430	217, 436	6.7	49/ 22
DIP(50)/C ₆₀ (40)	100/100	15, 110, 170	110, 193	5.3	49/46
DIP(4)/DIP:C ₆₀ (36)	100/100	120, 550	243, 697	6.2	48/27



Figure 6. Concept of crystallization in DIP/C₆₀ organic solar cells for different types of cell architecture obtained from GISAXS, XRR and AFM measurements. a) corresponds to the sample without substrate heating during the whole deposition process, b) to the sample with substrate heating (100 °C) during deposition of DIP, c) to the sample with substrate heating (100 °C) during deposition of both DIP and C₆₀ and d) to the sample with a coevaporated bulk heterojunction of DIP:C₆₀ on a thin DIP seed layer with substrate heating at 100 °C.

the case of the sample without substrate heating during deposition of C_{60} . These findings are a remarkable example, that the morphology in heterolayers cannot be predicted based on measurements performed on the underlying neat layer, even for the same substrates. Unexpected behavior of PV cell characteristics could thus possibly be assigned to unknown layer reorganization during deposition of top layers.

Regarding roughness correlation a different behavior as compared to the neat DIP films is seen. For large structures in the films (from vertical cuts at $q_y = 0$), a correlated roughness is present after C₆₀ evaporation for room temperature and 100 °C. In addition, for small particles, as obtained from the oscillations in the q_z -cut at the position of the maximum in q_y , a correlated roughness is obtained which is even more pronounced than for the larger structures.

3.3. Planar-Mixed Architecture (Thick co-Evaporated Mixture of DIP and C_{60} on DIP)

For the planar-mixed layer system, XRR reveals a vertical coherence length of about 48 nm for DIP and 27 nm for C_{60} . These values are comparable to the domain size in the unheated bilayer system.

AFM measurements show a different morphology as compared to all the other samples. Instead of sphere or granule-like domains, the morphology can be described as large interconnected domains with small sphere-like objects being placed on top.

FFT analysis of the AFM data reveals that the spongy shape of the underlying DIP exhibits a domain distance of about 700 nm. Obviously small C_{60} grains are distributed within the DIP host structure with a mean distance of about 240 nm. The GISAXS data analysis results in two dominant lateral lengths as well. In comparison to the planar layer system larger structures are detected with a different shape, as it is apparent from the AFM measurements, too.

In addition to the interpretation via EIA, the GISAXS data of the planar-mixed layer system has been simulated with IsGISAXS^[27] (not shown), based on the Distorted Wave Born Approximation (DWBA) in the framework of the local monodisperse approximation (LMA), resulting from monodisperse subsystems.^[31] The peak position of the interference function corresponds to a domain distance of 120 nm as determined with EIA. The used model can be understood as spherically shaped C₆₀ domains with a radius of 23 nm mixed with cylindrically shaped DIP domains with a radius of 89 nm and a mean distance of 120 nm. As the mean distance for the DIP domains is smaller than their diameter, the DIP domains are agglomerated, in agreement with the AFM data. The height of the C60 domains as obtained from the simulation is 50 nm, while it is about 180 nm for the DIP. We note that the mentioned values for domain heights and radii of C60 and DIP are simulation parameters that have been determined by a cumulative fit of several q_{v} - and q_{z} -cuts of the simulation results to measured data. In comparison with the vertical domain sizes as obtained from XRR as 27 nm and 48 nm, the domain heights determined with the IsGISAXS simulation are larger by a factor of 2 and 4, respectively. This difference indicates that the spherically shaped C₆₀ domains are in average present at a finite height above the substrate and that DIP is present below and between the C60 domains. Table 1 summarizes the comparison between values obtained by GISAXS for the sample volume and values obtained by AFM for the sample surface. For both, the large structures in the film, and for the small particles, correlated roughness is observed in case of coevaporation of DIP and C₆₀.

The structural information gained from GISAXS, XRR and AFM measurements can now be converted to a concept how DIP and C_{60} grow in the respective OPVC devices (see **Figure 6**). For subsequent evaporation of DIP and C_{60} at RT, small crystallites of DIP and C_{60} are present on top of each other. A higher substrate temperature during evaporation of DIP results in larger DIP crystallites, while a higher substrate temperature during C_{60} evaporation forces the underlying DIP to reorganize and reduces its crystallite size; in contrast, C_{60} crystallites grow larger. In the case of coevaporation, C_{60} crystallites are incorporated into the spongy morphology of interconnected huge DIP crystallites. In all cases, the vertical dimensions of the DIP crystallites are as large as the film thickness.

3.4. Solar Cell Performance

To compare results from morphology and structure investigations to the solar cell performance, the growth behavior has to be similar on the two different substrates used. Comparing our



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Figure 7. j–V-characteristics of organic solar cells with layer stacks comparable to the samples for structural and morphological investigations. The extracted device parameters are listed in Table 2.

results (see Figure 2) with published data (see Ref. [20]) this necessary precondition is fulfilled for DIP grown on SiO₂ and ITO/PEDOT:PSS. Also the values for vertical domain distances (see Table 1) show similar crystallization behavior on both substrates in agreement with the results from Ref. [20]. However, we note that for technical reasons related to GISAXS, the C₆₀ layers are thinner in the present study and thus not optimized for OPVC performance.

As mentioned in the introduction, morphology and structure are critically influencing the solar cell performance. Due to the strong changes of lateral feature sizes in the layers caused by different fabrication conditions, variations in the characteristic values for the corresponding OPVCs are expected. Thus, it is even more surprising that the solar cells without heating during C_{60} deposition do not differ significantly, except for the fill factor which slightly decreases for lower substrate temperatures during deposition of DIP caused by a prospective s-shape in *j*–V characteristics, see **Figure 7** and **Table 2**. In this case the formation of s-shaped *j*–V characteristics results from a less pronounced

Table 2. Characteristic device parameters of organic photovoltaic cells with active layer stacks corresponding to the samples listed in Table 1. In this case, the organic layers were deposited on ITO/PEDOT:PSS substrates with a BCP/Al top electrode. The electrical measurements were performed under simulated AM 1.5 conditions.

Layer Sequence (Thickness [nm])	Temp. [°C]	j _{sc} [mA/cm]	V _{oc} [V]	FF [%]	η [%]
DIP(50)/C ₆₀ (40)	RT/RT	3.05 ± 0.22	0.915 ± 0.002	65.6±1.0	1.83 ± 0.07
DIP(50)/C ₆₀ (40)	60/RT	3.04 ± 0.12	0.913 ± 0.002	66.1 ± 0.6	1.84 ± 0.07
DIP(50)/C ₆₀ (40)	100/RT	$\textbf{3.20} \pm \textbf{0.14}$	0.907 ± 0.002	68.3 ± 0.4	1.98 ± 0.08
DIP(50)/C ₆₀ (40)	100/100	3.16 ± 0.17	$\textbf{0.902} \pm \textbf{0.008}$	61.1 ± 1.1	1.74 ± 0.11
DIP(4)/DIP:C ₆₀ (36)/C ₆₀ (6)	100/100/RT	4.41 ± 0.06	0.881 ± 0.005	44.1 ± 1.2	1.71 ± 0.02

increase of forward current in the first quadrant. This can mainly be attributed to an injection barrier at the PEDOT:PSS/donor interface, which is reduced by heating the substrate due to an increase of the work function of PEDOT:PSS. For that reason the substrates of the samples without heating and heating at 60 °C during deposition of DIP were pre-annealed to 100 °C in the vaccum chamber and cooled down to the distinct temperature before DIP film deposition, otherwise the s-shape in the j-V characteristics would be more pronounced and would influence the FF of the solar cells severely. For detailed information about s-shapes in DIP/ C₆₀ solar cells see Ref. [32]. Apart from these minor changes in fill factor by s-shapes, i-Vcharacteristics are almost identical despite the fact that lateral domain distances vary by a factor of around 3 between DIP layers prepared on unheated and heated (100 °C) substrates. For DIP on unheated substrates lateral electron and hole mobilities are in the range of 10^{-1} cm²/Vs and 10^{-2} cm²/Vs,^[33] respectively, and will even be better for larger domain sizes. However, being an in-plane

property of the film, minor influence on OPVC performance is to be expected, as charge carrier transport and diffusion processes are dominated by film properties along the layer normal. Out-of-plane structural properties stay nearly the same, i.e. the vertical DIP domain size is approaching the layer thickness leading to comparable transport and diffusion behavior regardless of the substrate temperature during DIP growth. C_{60} just overgrows the DIP layer, when the substrate is not heated during deposition of C_{60} comprising 20 nm thick crystals. Thus all structural and morphological parameters are preserved for these three samples yielding comparable characteristic values in OPVCs.

Compared to the PHJ OPVCs, where the substrate is held at room temperature during C_{60} deposition, the sample with further substrate heating during C_{60} deposition exhibits a decreased FF, which is not an effect resulting from an injection barrier, as the forward current does not show an s-shape. In fact, this seems to result from a reduced parallel resistance as the current is not saturating for negative voltages.^[34] These changes in FF are obvi-

ously related to structural and morphological changes as they were observed by GISAXS, AFM and XRR. Thus, the crucial factor can most likely be associated to the reorganization of the DIP layer, where lateral grain size is shrinking as compared to the solar cell without substrate heating during C_{60} deposition. However, lateral grain shrinking is probably not the only reason for changes in OPVC characteristics, as there are only small changes for the OPVCs with unheated substrate during C_{60} deposition, only differing in lateral grain distances of DIP. A possibe explanation may be found in C_{60} diffusing into the



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DIP film during the reorganization process, which leads to a larger interface and encapsulated C_{60} islands in the DIP film.^[35] An effect like this could explain changes in all three characteristic parameters of the OPVC. Encapsulation of C_{60} in the DIP film leads to an increased series resistance due to trapping of charges on the islands and increases the D/A interface, which leads to enhanced recombination. While trapping of charges reduces the FF, increased recombination rates lower $V_{\rm OC}$. The overall effect of the reorganization process would direct the characteristic values towards those of a PM-HJ. This can be seen in the *j*–V characteristics (see Figure7 and Table 1).

Due to the PM-HJ containing mainly mixed material, island formation for C_{60} is very pronounced, which severly reduces the FF. Compared to the PHJ cells, V_{OC} is slightly reduced because of the huge interface between DIP and C_{60} , which leads to higher recombination losses.^[21] Despite these reductions, efficiency stays nearly the same in the range of standard deviation resulting from the gain of j_{SC} . This can be explained by the fact, that the phase separated BHJ of DIP and C_{60} is composed of domains of both materials being in clsoe proximity to each other. Thus, the majority of excitons is dissociated within the range of EDL.^[20,13,37] The high crystallinity of both materials can explain the almost equal efficiencies of the PHJ and PM-HJ OPVCs, as EDLs are very high in crystalline materials and the gain of j_{SC} by mixing both materials is compensated by the exceptionally high FFs of PHJ devices.^[36]

4. Conclusion

Structural and morphological issues play an important role in solar cell performance. In our study we showed how fabrication conditions can alter the lateral and vertical crystalline coherence in thin films of DIP and C_{60} . In the literature, typically effects such as structural differences in materials grown on different substrates are taken into account, whereas effects which are caused by a reorganization of the underlying films are often neglected. Our structural and morphological investigations show that these reorganization processes can be very pronounced and lead to noticable changes in electronic devices, rendering them an important issue that needs to be considered. However, advanced scattering techniques such as GISAXS are required to detect such changes in buried layers.

Particularly, neat DIP layers deposited on differently heated substrates yield increasing lateral domain distances for higher temperatures. Depending on the further temperature treatment of the substrate during C₆₀ deposition, the acceptor can simply overgrow the DIP topography (unheated substrate) or result in significant reorganization of the underlying DIP layer accompanied by higher crystallinity in vertical direction (heated substrate). This reorganization does not only influence the respective layer structure, but, interpreting the *j*–*V* characteristics of equivalent organic solar cells, gives rise to the assumption that also intermixing of the two materials at the interface takes place. In all neat films and bilayer systems surface morphology measured by AFM and bulk structure measured by GISAXS exhibit nearly the same lateral domain distances, which is also an indication for C₆₀ growing with

correlated roughness on DIP. In contrast, domain distances extracted from surface and bulk measurements are quite different in planar-mixed layer systems indicating a completely different growth behavior. This results in DIP forming interconnected sponge-like structures sourrounded by C_{60} agglomerations, leading to significant changes in j–V characteristics – most importantly, a reduction of the fill factor – as compared to the bilayer systems. This is a clear signature of increased recombination losses as a consequence of an unfavourable morphology for charge carrier extraction from mixed donor–acceptor structures.

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